

Radiation Damage

E.Fretwurst, R.Klanner, H.Perrey, I.Pintilie^{*)},
A.Srivastava, T.Theedt

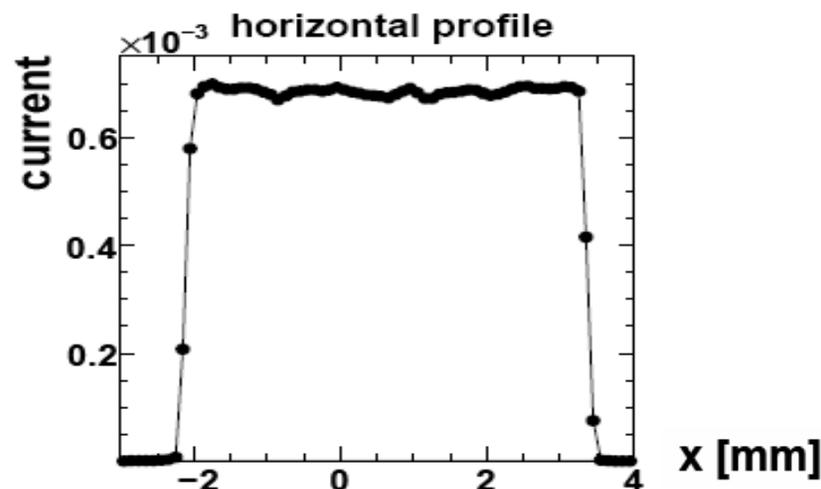
(Univ. Hamburg, ^{*)}National Inst. Materials, Romania)

1. X-ray irradiation facility - new irradiations
2. Reminder: Status at last XDAC-meeting
3. X-ray radiation damage: new effects and first understanding
4. First results of annealing studies
5. Outlook - next steps

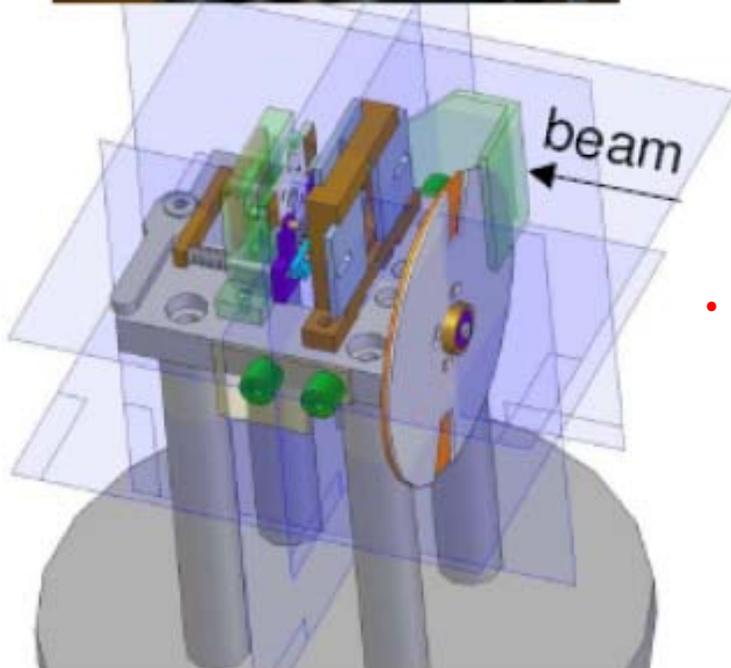
1. X-ray irradiation facility - new irradiations



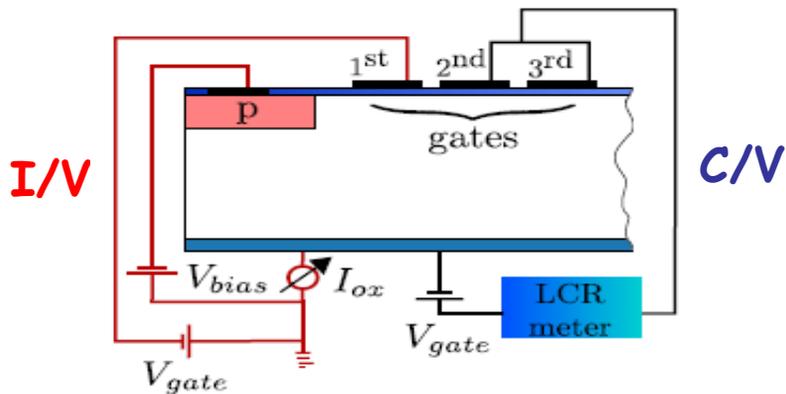
- Improved uniformity by vertical scanning
- Re-measurement of horizontal profile



- Irradiation of test structures repeated
 - verify previous results
 - check effect of vertical non-uniformity
 - assure better defined "annealing-status" (put samples in freezer to avoid room temperature annealing)

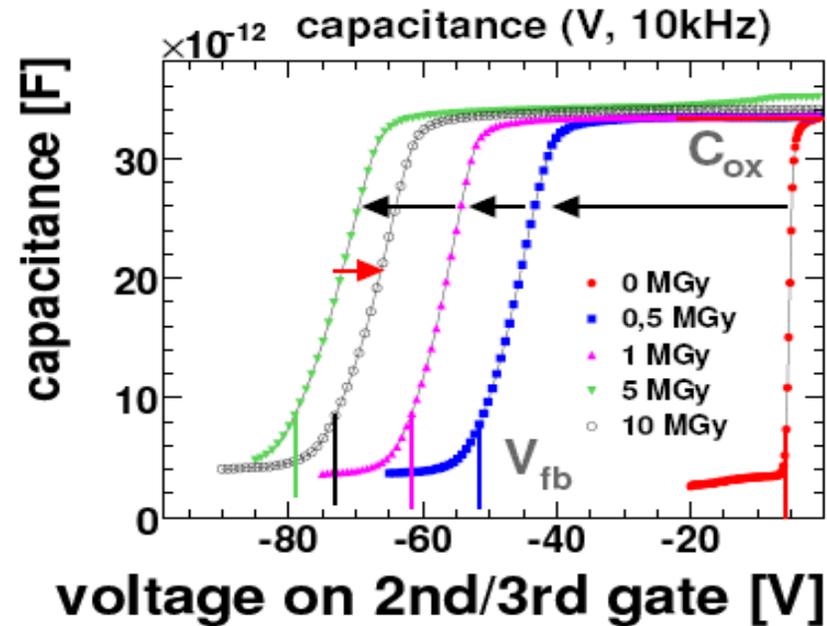
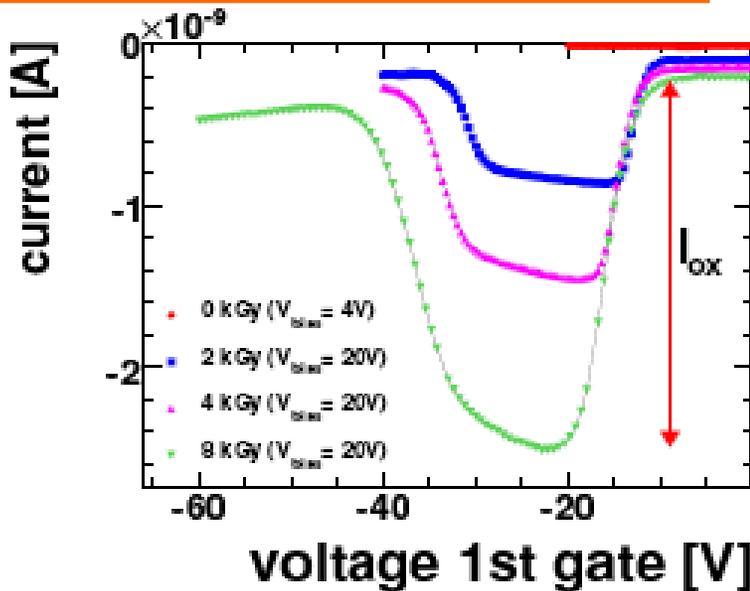


2. Status at last XDAC-meeting - measurement techniques



$N_{it} + N_{Ox}$ (interface trap- + oxide charge-density) from V-shift of C/V curve
 N_{it} also \rightarrow frequency dependence of C/V

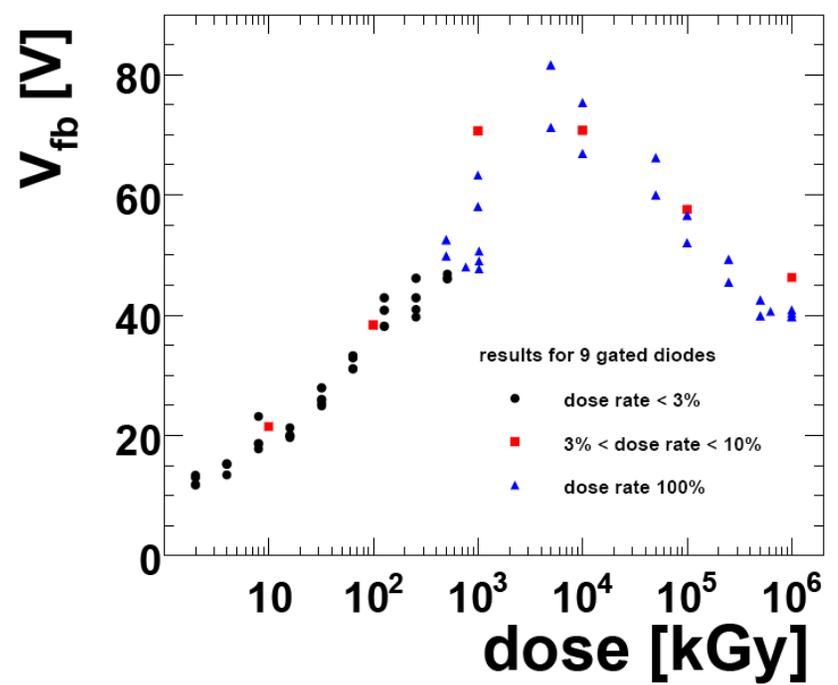
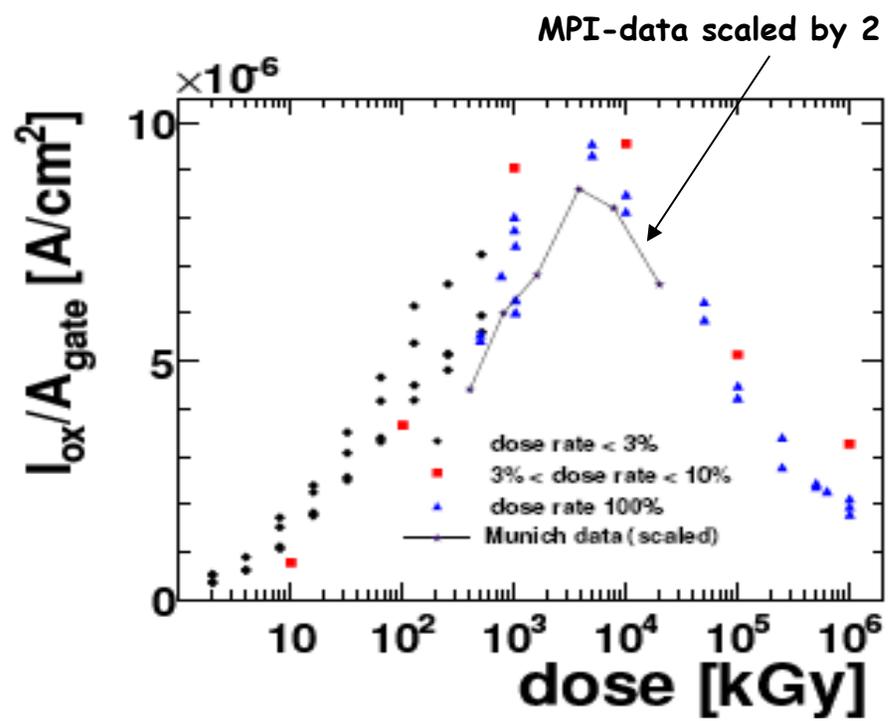
I_{Ox} (oxide current): from I/V when Si below gate in depletion



D_{it} (distribution of interface traps in band gap [$cm^{-2}eV^{-1}$]) from TSC (Thermally Stimulated Current technique)

Status at last XDAC-meeting - main results:

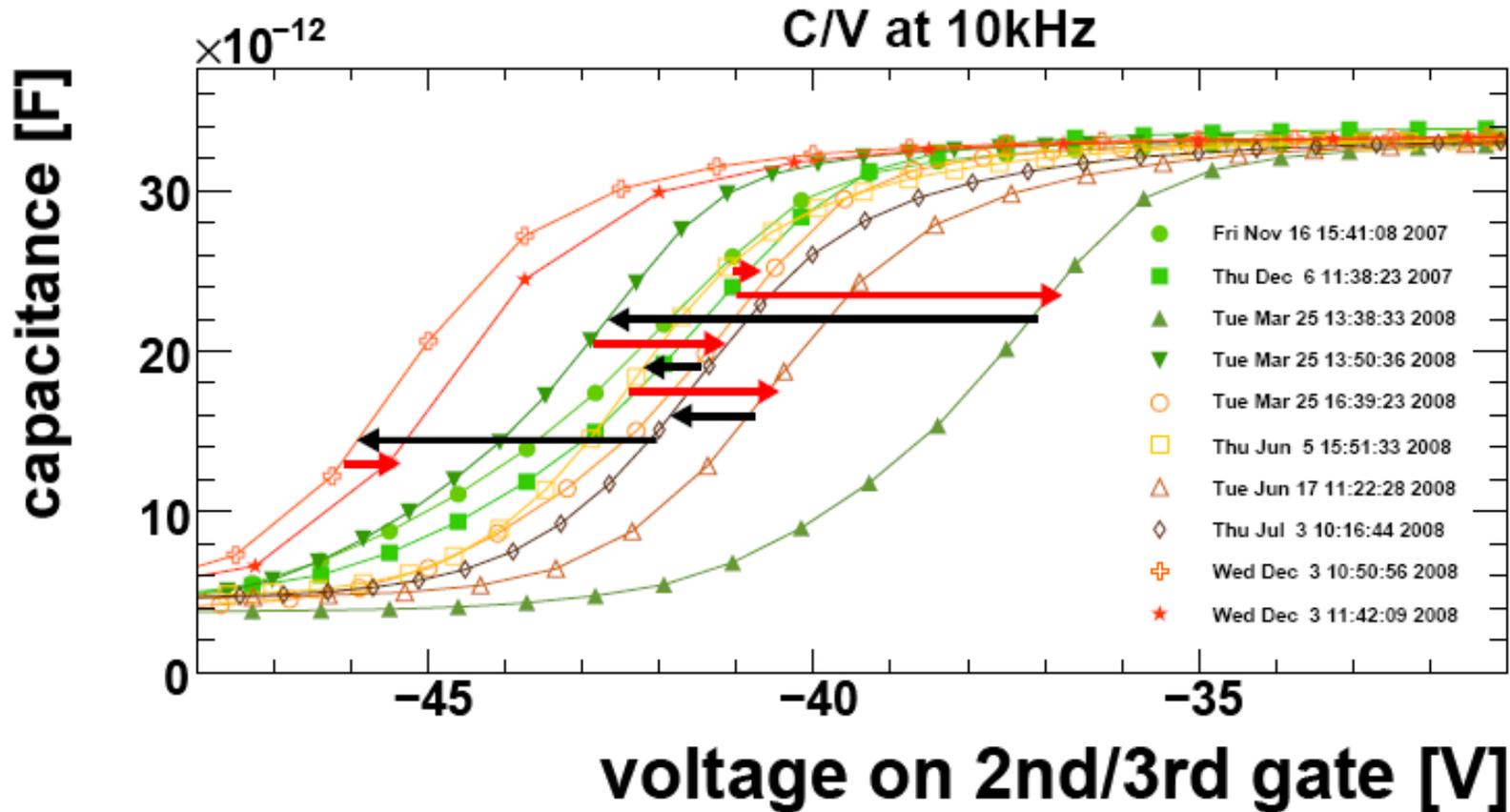
Surface generation current vs dose "Flat-band voltage" vs dose



→ $V_{fb} [N_{Ox} + N_{it}]$ and $I_{Ox} [N_{it}]$ reach maximum at few MGy - then decrease
 (tentative conclusion: decrease due to N_{it} at high doses - reason not clear)

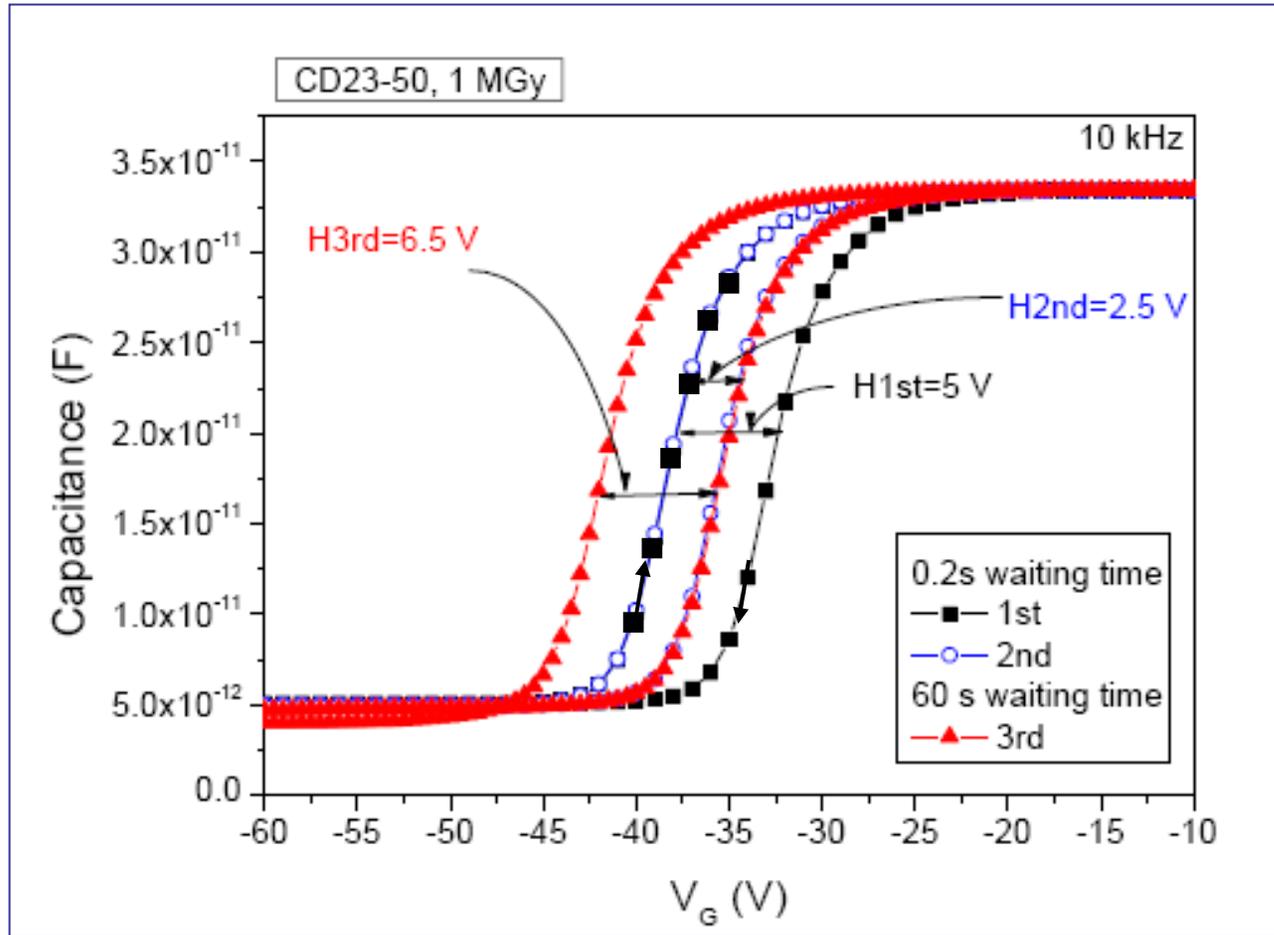
3. New effects and (attempt of a) first "understanding":

C/V measurements exhibit a random component (hidden parameter)



→ quasi random shifts at the level of $O(10 \text{ Volts})$!

Observation of strong hysteresis and temperature effects:
 (→ C/V curve depends (eg) on stepping speed and direction of V)



→ N_{Ox} component with long ($\gg 1/f_{AC}$) time constant → dependence on biasing history

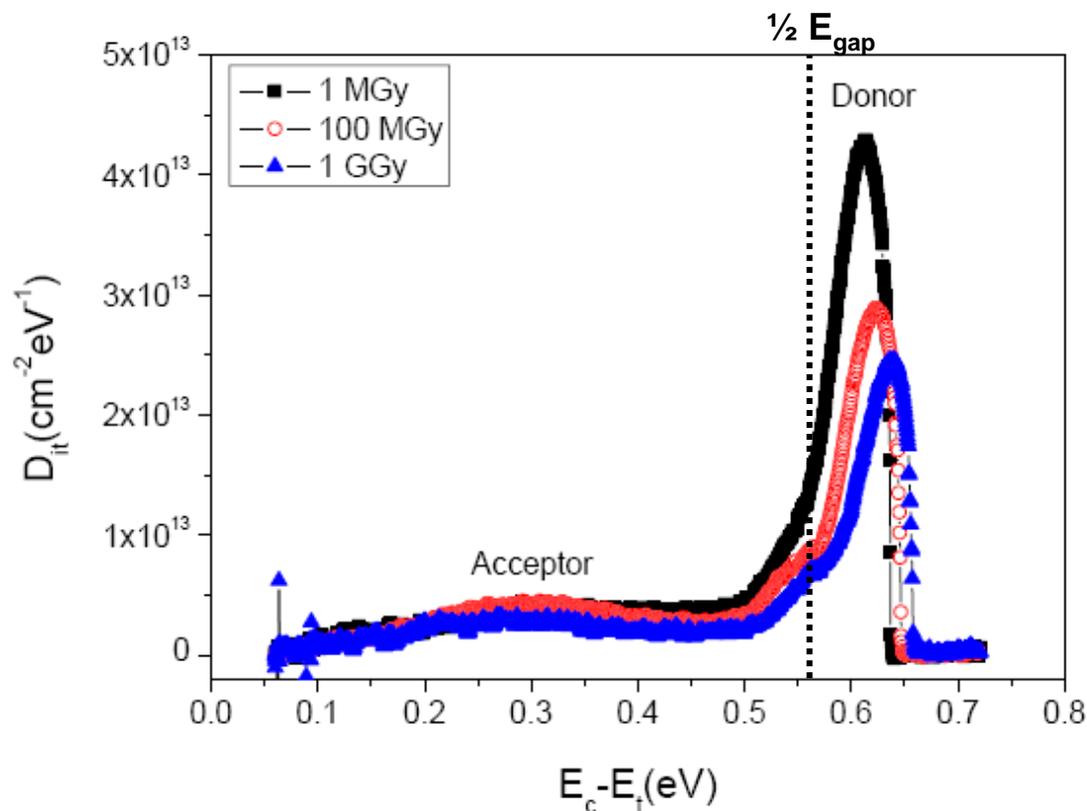
→ assume 3 components of irradiation effects:

1. N_{Ox}^{fix} **fixed** oxide charges → shift of ideal CMOS-C/V-curve (no bending C/V, no f -dependence C/V, no I_{Ox})
2. N_{Ox}^{mob} **mobile** oxide charges (close to interface) → shift C/V-curve, no f -dependence C/V, responsible for hysteresis effects, no I_{Ox})
3. D_{it} **interface traps** (integral N_{it}) → oxide charges (close to interface) → shift C/V-curve (N_{it}), f -dependence C/V, I_{Ox} (D_{it} close to mid-band)

attempt to use disentangle the 3 components:

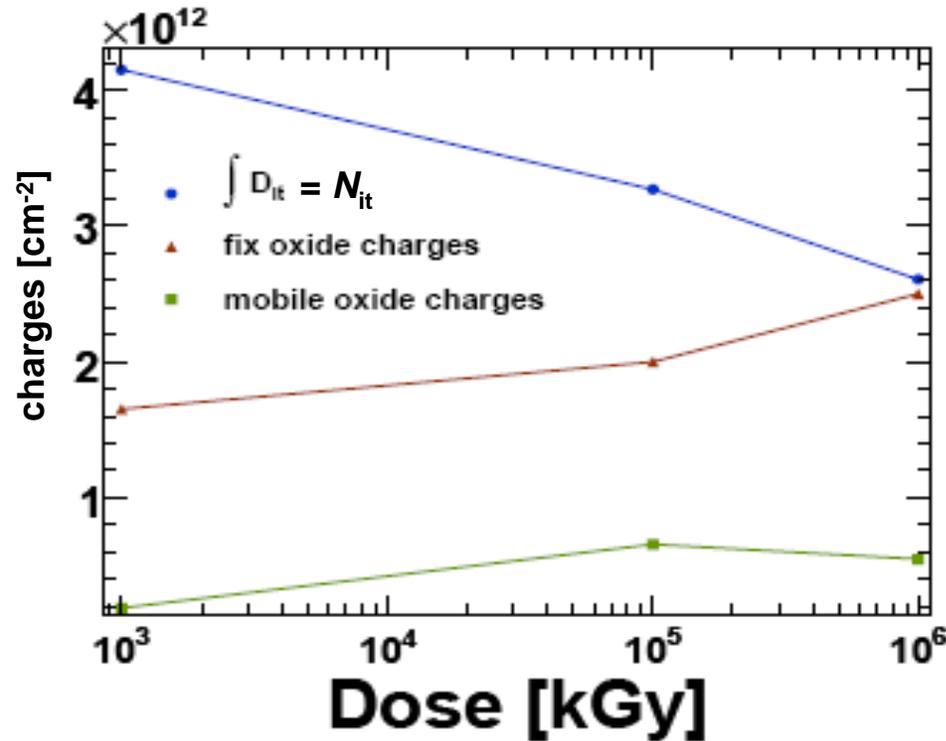
- obtain D_{it} and N_{it} from TSC-measurements
- simulate C/V curve and compare the shape
- "erase" mobile charges (eg anneal 30' at 80°C) → 1st "fast" C/V curve is determined only by N_{Ox}^{fix} and N_{it}
- obtain N_{Ox}^{mob} from "C/V" hysteresis for fast (0.2 sec waiting time) C/V-curve (0 → -80 → 0Volts) [result depends on waiting time at -80Volts]
- verify that simulation describes data
- check that results are consistent with I_{Ox} results

D_{it} [$\text{cm}^{-2}\text{eV}^{-1}$] Interface density vs Irradiation dose (from TSC thermally Stimulated Current- measurements):

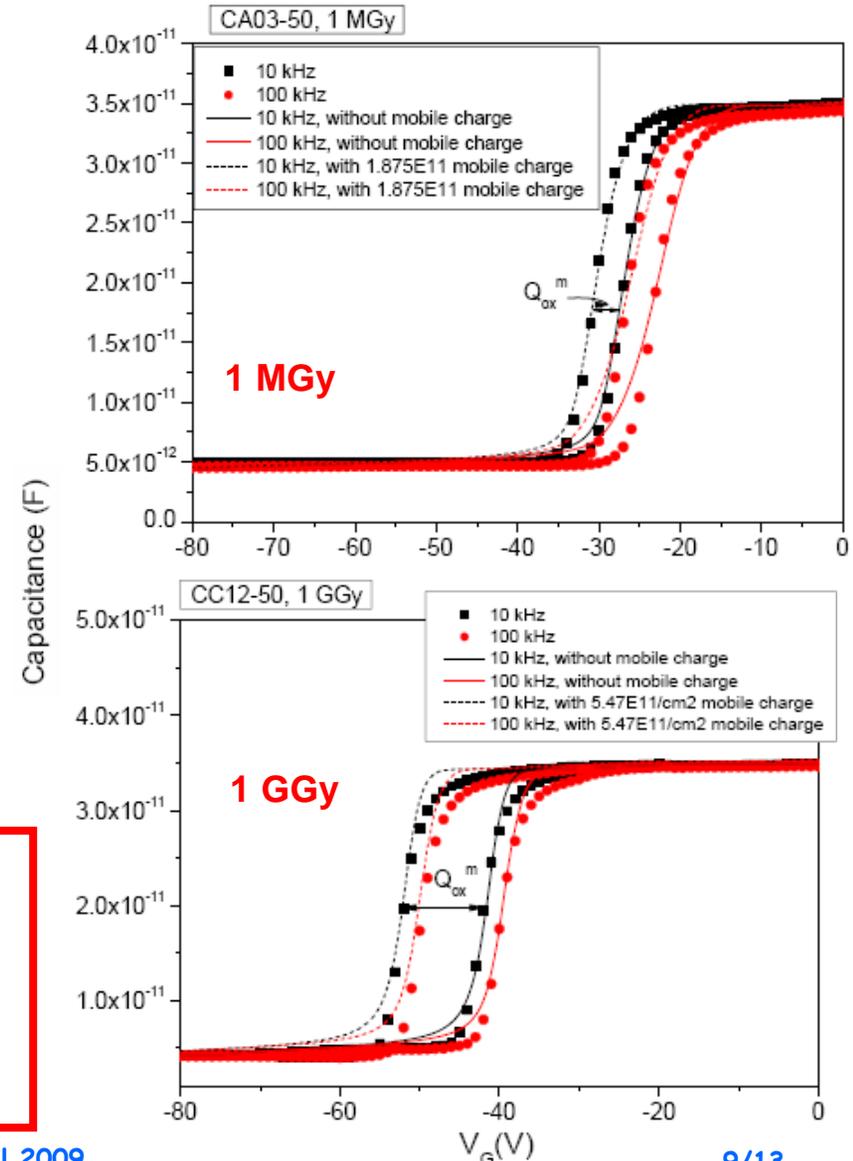


→ significant decrease (1 MGy → 1 GGy) of D_{it}
in particular close to the middle of the band gap, where sensitivity to I_{Ox} highest

Results:



Comparison to measurements:



→ results preliminary - have to be checked

- data can be described by microscopic model, which can be put into simulations
- reason for decrease of N_{it} not understood

“understanding” more complex than expected

4. First results from annealing studies:

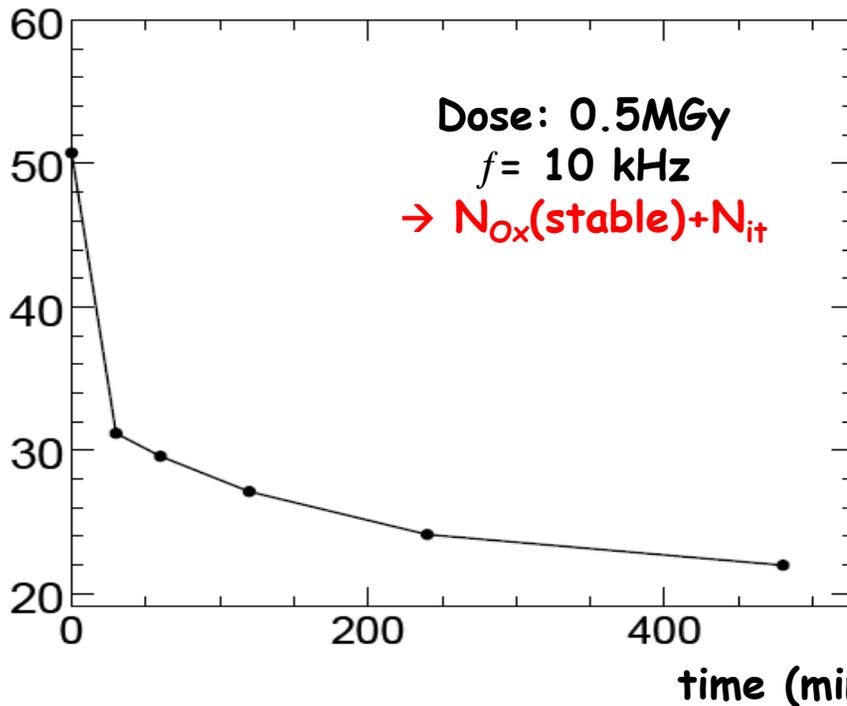
We have learned only recently to obtain reproducible results

→ delays in annealing studies

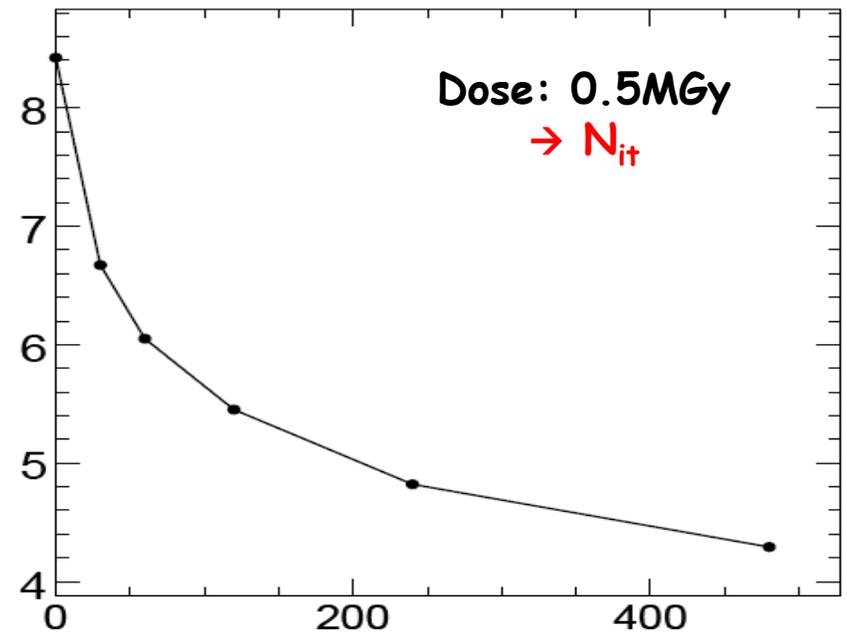
Start: measure CV, IV and TSC-spectra vs annealing time at 80°C:

→ first results

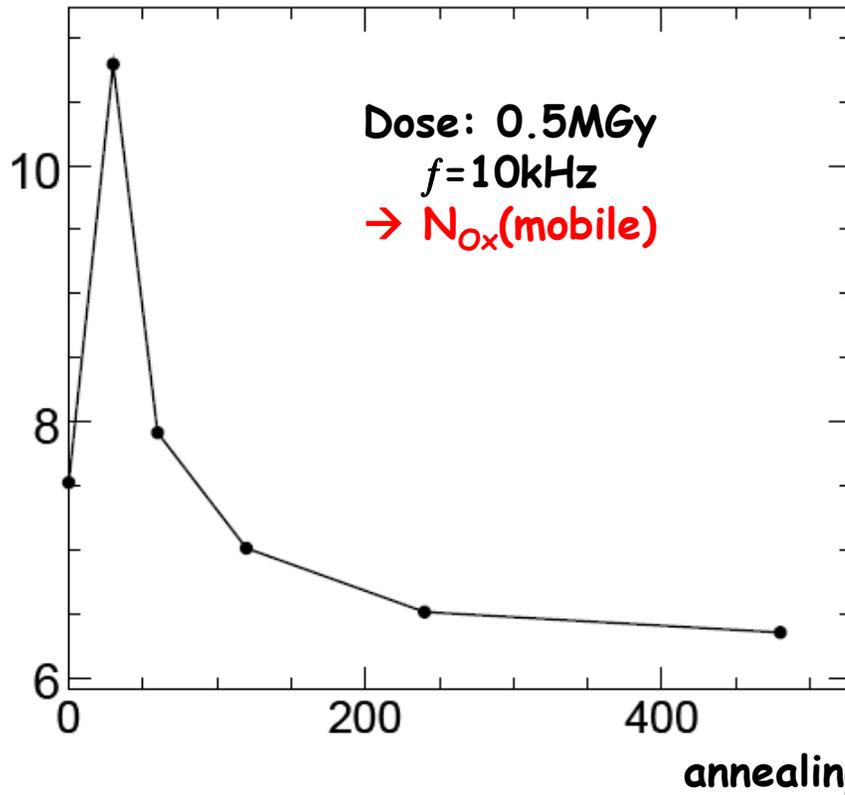
Voltage($C = \frac{1}{2} C_{\text{accum.}}$) [V] vs annealing time



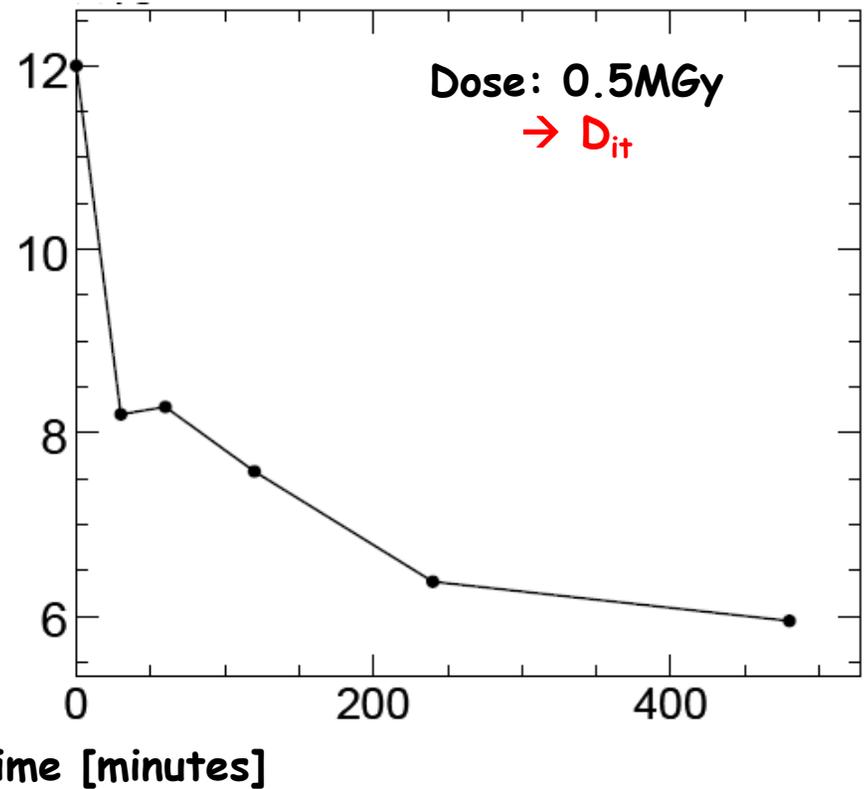
Δ Voltage(100kHz-10kHz) [V] vs $t_{\text{annealing}}$



$\Delta V(\text{hysteresis})[\text{V}]@10 \text{ kHz}$ vs $t_{\text{annealing}}$



$I_{\text{Ox}} (\text{nA})$ vs $t_{\text{annealing}}$



\rightarrow strong annealing effects observed